

PDTA143X/123J/143Z/114YQA Series 50 V, 100 mA PNP resistor-equipped transistors

Rev. 1 — 30 October 2015

Product data sheet

Product profile 1.

1.1 General description

100 mA PNP Resistor-Equipped Transistor (RET) family in a leadless ultra small DFN1010D-3 (SOT1215) Surface-Mounted Device (SMD) plastic package with visible and solderable side pads.

Table 1. **Product overview**

Type number	R1	R2	Package NXP	NPN complement
PDTA143XQA	4.7 kΩ	10 kΩ	DFN1010D-3	PDTC143XQA
PDTA123JQA	2.2 kΩ	47 kΩ	(SOT1215)	PDTC123JQA
PDTA143ZQA	4.7 kΩ	47 kΩ		PDTC143ZQA
PDTA114YQA	10 kΩ	47 kΩ		PDTC114YQA

1.2 Features and benefits

- 100 mA output current capability
- Built-in bias resistors
- Simplifies circuit design
- Reduces component count

1.3 Applications

- Digital applications
- Cost saving alternative for BC847/BC857 series in digital applications

1.4 Quick reference data

Table 2. **Quick reference data**

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
V _{CEO}	collector-emitter voltage	open base	-	-	-50	V
I _O	output current		-	-	-100	mA



- Reduced pick and place costs
- Low package height of 0.37 mm
- AEC-Q101 qualified
- Suitable for Automatic Optical Inspection (AOI) of solder joint
- Controlling IC inputs
- Switching loads

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2. Pinning information

Table 3.	Pinning			
Pin	Symbol	Description	Simplified outline	Graphic symbol
1	I	input (base)		
2	GND	GND (emitter)		
3	0	output (collector)		
4	0	output (collector)	2 4 3 Transparent top view	GND

3. Ordering information

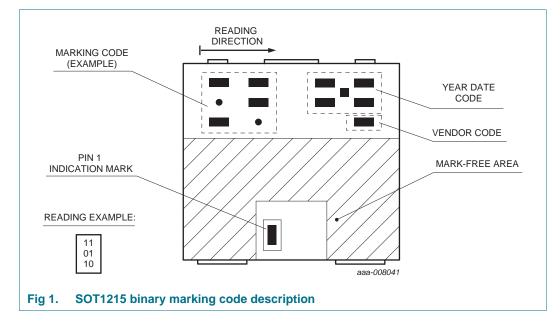
Table 4. Ordering information							
Type number	Package						
	Name	Description	Version				
PDTA143XQA	DFN1010D-3	plastic thermal enhanced ultra thin small outline	SOT1215				
PDTA123JQA		package; no leads; 3 terminals; body: $1.1 \times 1.0 \times 0.37$ mm					
PDTA143ZQA							
PDTA114YQA							

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4. Marking

Table 5.Marking codes	
Type number	Marking code
PDTA143XQA	11 11 10
PDTA123JQA	11 00 01
PDTA143ZQA	11 01 01
PDTA114YQA	11 10 11

4.1 Binary marking code description



5. Limiting values

Table 6. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions	Min	Max	Unit			
V _{CBO}	collector-base voltage	open emitter	-	-50	V			
V _{CEO}	collector-emitter voltage	open base	-	-50	V			
V _{EBO}	emitter-base voltage							
	PDTA143XQA		-	-7	V			
	PDTA123JQA		-	-5	V			
	PDTA143ZQA		-	-5	V			
	PDTA114YQA		-	-6	V			

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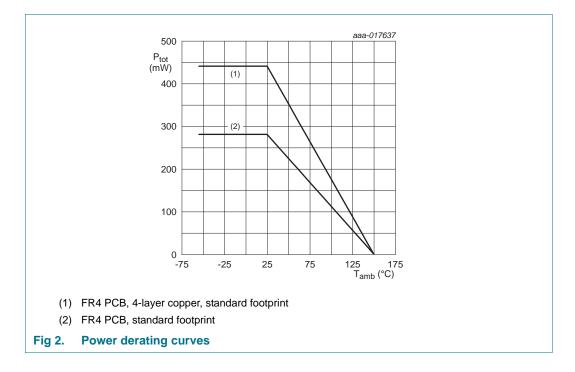
Table 6. Limiting values ...continued

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions	Min	Max	Unit
VI	input voltage				
	PDTA143XQA		-30	+7	V
	PDTA123JQA		-12	+5	V
	PDTA143ZQA		-30	+5	V
	PDTA114YQA		-40	+6	V
I _O	output current		-	-100	mA
P _{tot}	total power dissipation	$T_{amb} \le 25 \ ^{\circ}C$	<u>[1]</u> -	280	mW
			[2] -	440	mW
Tj	junction temperature		-	150	°C
T _{amb}	ambient temperature		-55	+150	°C
T _{stg}	storage temperature		-65	+150	°C

[1] Device mounted on an FR4 Printed-Circuit Board (PCB), single-sided copper, tin-plated and standard footprint.

[2] Device mounted on an FR4 PCB, 4-layer copper, tin-plated and standard footprint.



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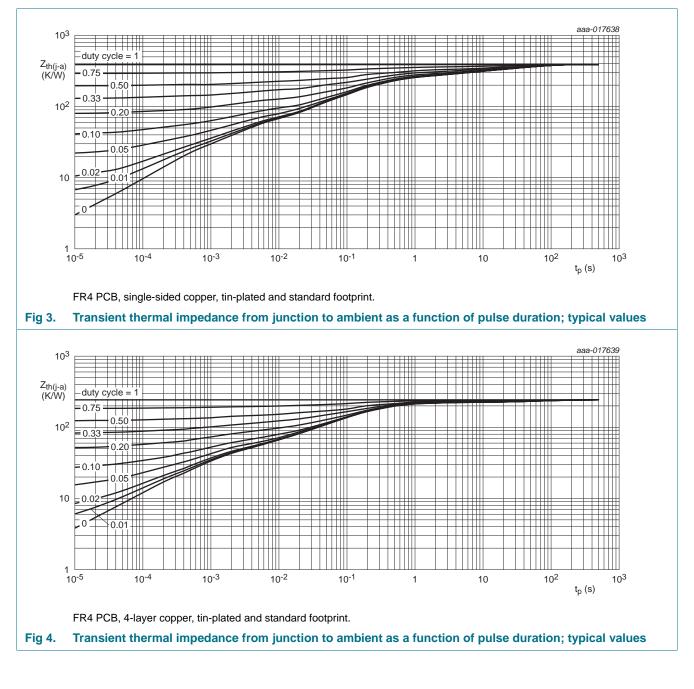
Thermal characteristics 6.

Table 7. Ther	mai characteristics					
Symbol	Parameter	Conditions	Min	Тур	Max	Unit
ung a)		in free air	<u>11</u> -	-	446	K/W
	to ambient]	<u>2]</u> -	-	284	K/W

al alsona staniation

[1] Device mounted on an FR4 PCB, single-sided copper, tin-plated and standard footprint.

Device mounted on an FR4 PCB, 4-layer copper, tin-plated and standard footprint. [2]



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Characteristics 7.

Symbol	Parameter	Conditions	Min	Тур	Max	Unit			
I _{CBO}	collector-base cut-off current	$V_{CB} = -50 \text{ V}; I_E = 0 \text{ A}$	-	-	-100	nA			
I _{CEO}	collector-emitter cut-off	$V_{CE} = -30 \text{ V}; \text{ I}_{B} = 0 \text{ A}$	-	-	-1	μA			
	current	V _{CE} = -30 V; I _B = 0 A; T _j = 150 °C	-	-	-5	μA			
I _{EBO}	emitter-base cut-off curr	ent							
	PDTA143XQA	$V_{EB} = -5 V; I_{C} = 0 A$	-	-	-600	μA			
	PDTA123JQA	-	-	-	-180	μA			
	PDTA143ZQA	-	-	-	-170	μA			
	PDTA114YQA	-	-	-	-150	μA			
h _{FE}	DC current gain								
	PDTA143XQA	$V_{CE} = -5 \text{ V}; \text{ I}_{C} = -10 \text{ mA}$	50	-	-				
	PDTA123JQA	$V_{CE} = -5 \text{ V}; \text{ I}_{C} = -10 \text{ mA}$	100	-	-				
	PDTA143ZQA	$V_{CE} = -5 \text{ V}; \text{ I}_{C} = -10 \text{ mA}$	100	-	-				
	PDTA114YQA	$V_{CE} = -5 \text{ V}; \text{ I}_{C} = -5 \text{ mA}$	100	-	-				
V _{CEsat}	collector-emitter saturati	on voltage							
	PDTA143XQA	$I_{\rm C} = -10$ mA; $I_{\rm B} = -0.5$ mA	-	-	-100	mV			
	PDTA123JQA	$I_{\rm C} = -5 \text{ mA}; I_{\rm B} = -0.25 \text{ mA}$	-	-	-100	mV			
	PDTA143ZQA	$I_{\rm C} = -5 \text{ mA}; I_{\rm B} = -0.25 \text{ mA}$	-	-	-100	mV			
	PDTA114YQA	$I_{\rm C} = -5 \text{ mA}; I_{\rm B} = -0.25 \text{ mA}$	-	-	-100	mV			
V _{I(off)}	off-state input voltage								
	PDTA143XQA	$V_{CE} = -5 \text{ V}; \text{ I}_{C} = -100 \mu\text{A}$	-	-0.9	-0.3	V			
	PDTA123JQA	-	-	-0.6	-0.5	V			
	PDTA143ZQA	-	-	-0.6	-0.5	V			
	PDTA114YQA	-	-	-0.7	-0.5	V			
V _{I(on)}	on-state input voltage								
	PDTA143XQA	$V_{CE} = -0.3 \text{ V}; I_{C} = -20 \text{ mA}$	-2.5	-1.5	-	V			
	PDTA123JQA	$V_{CE} = -0.3 \text{ V}; \text{ I}_{C} = -5 \text{ mA}$	-1.1	-0.75	-	V			
	PDTA143ZQA	$V_{CE} = -0.3 \text{ V}; \text{ I}_{C} = -5 \text{ mA}$	-1.3	-0.9	-	V			
	PDTA114YQA	$V_{CE} = -0.3 \text{ V}; \text{ I}_{C} = -1 \text{ mA}$	-1.4	-0.8	-	V			
R1	bias resistor 1 (input)		[1]						
	PDTA143XQA		3.3	4.7	6.1	kΩ			
	PDTA123JQA		1.54	2.2	2.86	kΩ			
	PDTA143ZQA		3.3	4.7	6.1	kΩ			
	PDTA114YQA		7	10	13	kΩ			

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Table 8. Characteristics ...continued

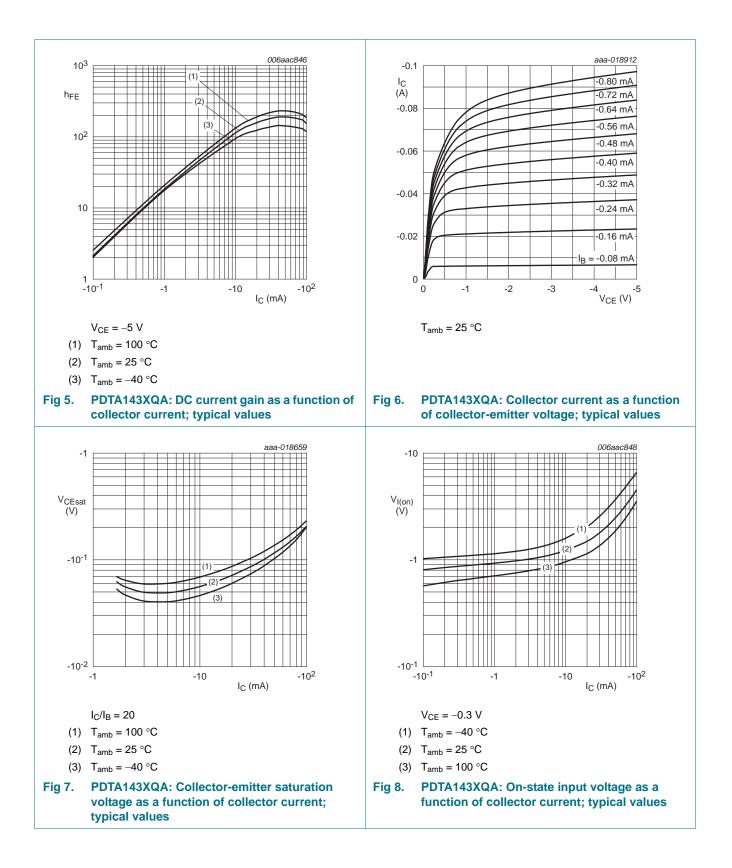
 $T_{amb} = 25 \ ^{\circ}C$ unless otherwise specified.

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
R2/R1	bias resistor ratio	<u>[1]</u>				
	PDTA143XQA		1.7	2.1	2.6	
	PDTA123JQA		17	21	26	
	PDTA143ZQA		8	10	12	
	PDTA114YQA		3.7	4.7	5.7	
C _c	collector capacitance	$V_{CB} = -10 \text{ V}; \text{ I}_{E} = \text{i}_{e} = 0 \text{ A}; \text{ f} = 1 \text{ MHz}$	-	-	3	pF
f _T	transition frequency	$V_{CE} = -5 \text{ V}; \text{ I}_{C} = -10 \text{ mA}; \text{ f} = 100 \text{ MHz}$ [2]	-	180	-	MHz

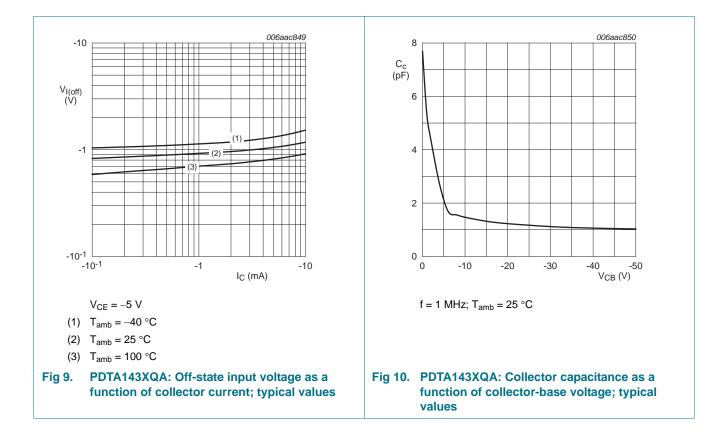
[1] See <u>Section 8 "Test information"</u> for resistor calculation and test conditions.

[2] Characteristics of built-in transistor.

PDTA143X/123J/143Z/114YQA

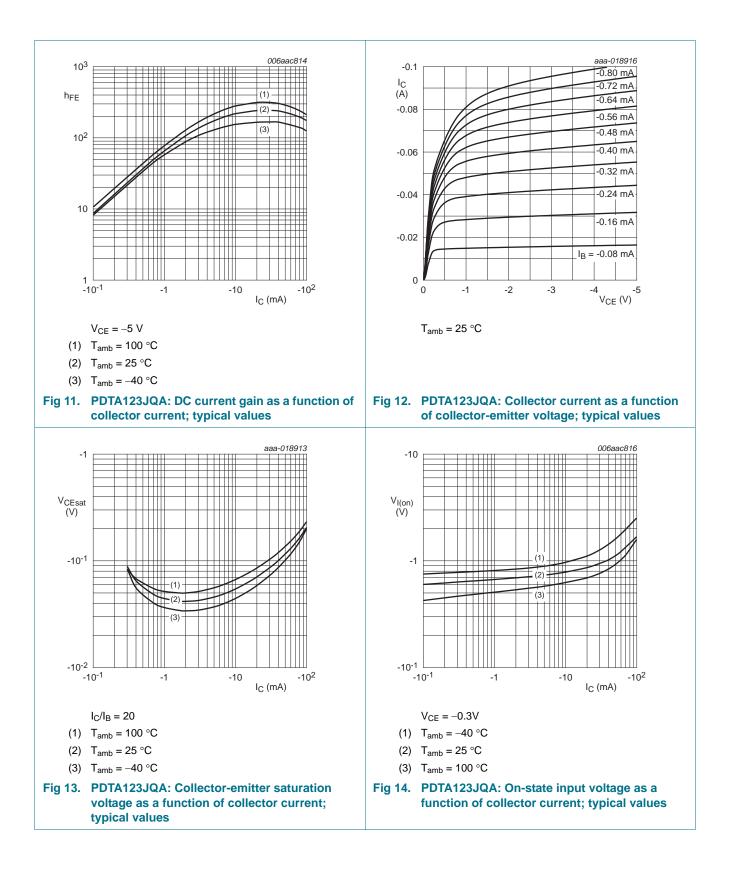


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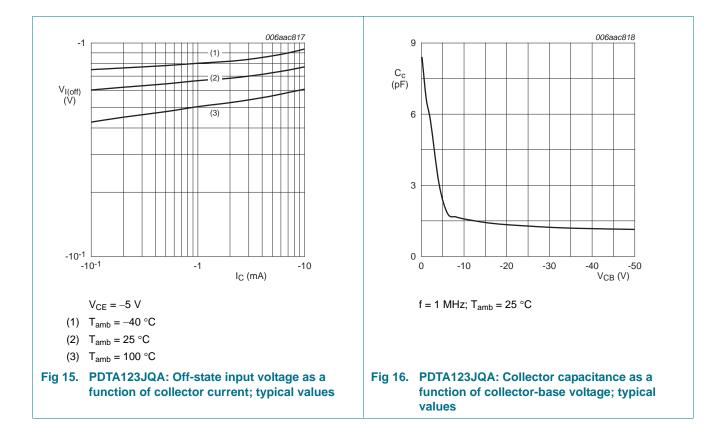


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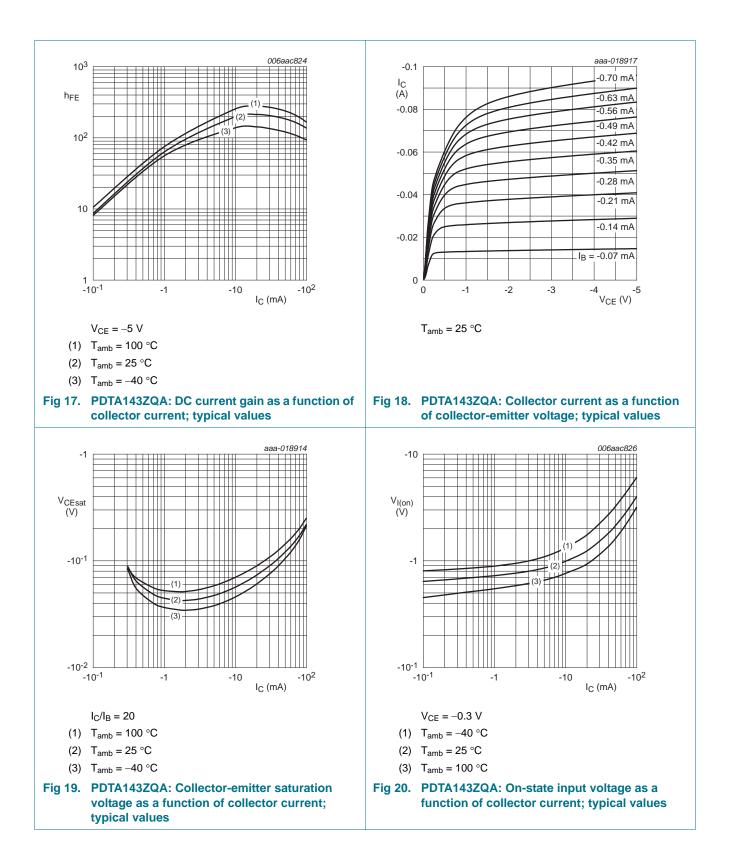


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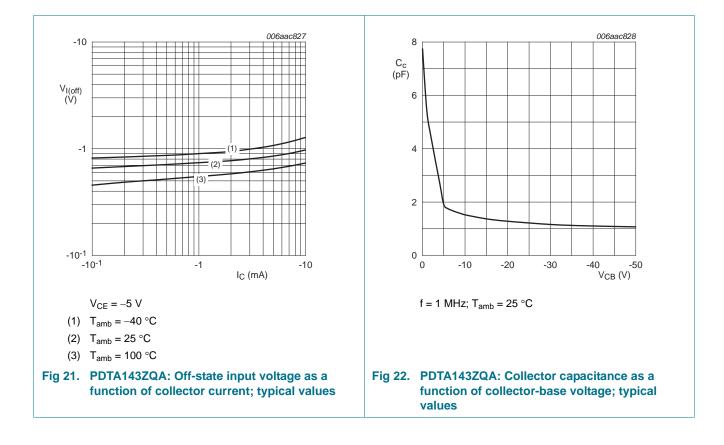


PDTA143X_123J_143Z_114YQA_SER

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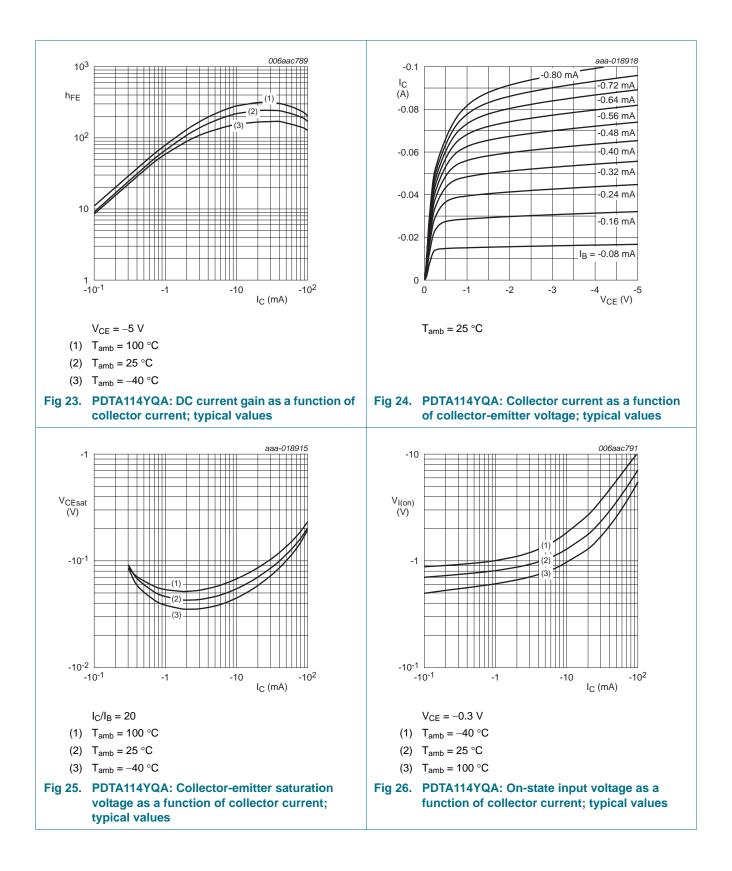
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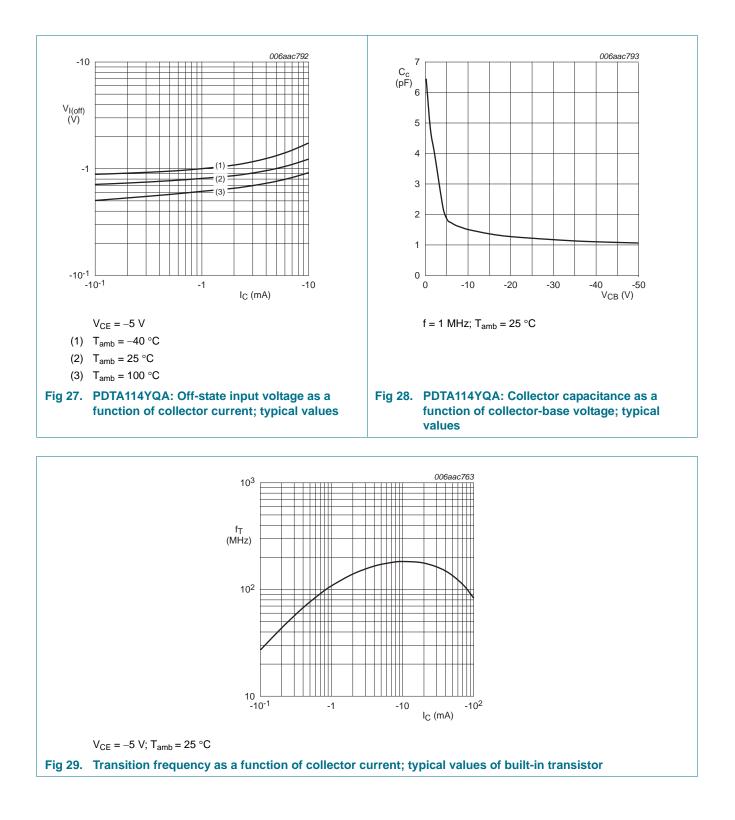
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8. Test information

8.1 Quality information

This product has been qualified in accordance with the Automotive Electronics Council (AEC) standard *Q101* - *Stress test qualification for discrete semiconductors*, and is suitable for use in automotive applications.

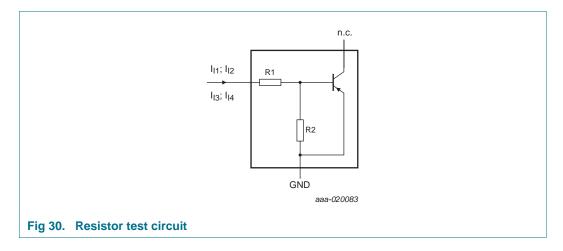
8.2 Resistor calculation

• Calculation of bias resistor 1 (R1):

$$R1 = \frac{V(I_{12}) - V(I_{11})}{I_{12} - I_{11}}$$

• Calculation of bias resistor ratio (R2/R1):

$$\frac{R2}{R1} = \frac{V(I_{I4}) - V(I_{I3})}{R1 \cdot (I_{I4} - I_{I3})} - 1$$



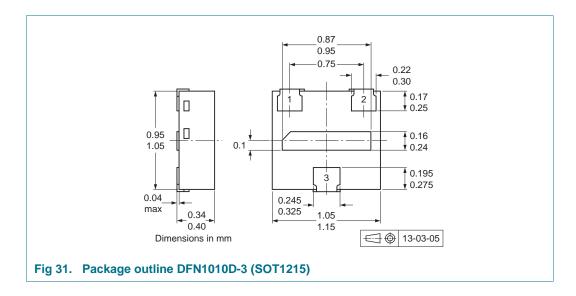
8.3 Resistor test conditions

Table 9.Resistor test conditions

Type number	R1 (kΩ)	R2 (kΩ)	Test conditions			
			I _{I1}	I ₁₂	I _{I3}	I ₁₄
PDTA143XQA	4.7	10	–350 μA	–450 μA	350 μA	450 μA
PDTA123JQA	2.2	47	–90 μA	–140 μA	55 μΑ	105 μA
PDTA143ZQA	4.7	47	–90 μA	–140 μA	55 μΑ	105 μA
PDTA114YQA	10	47	–90 μA	–140 μA	55 μΑ	105 μA

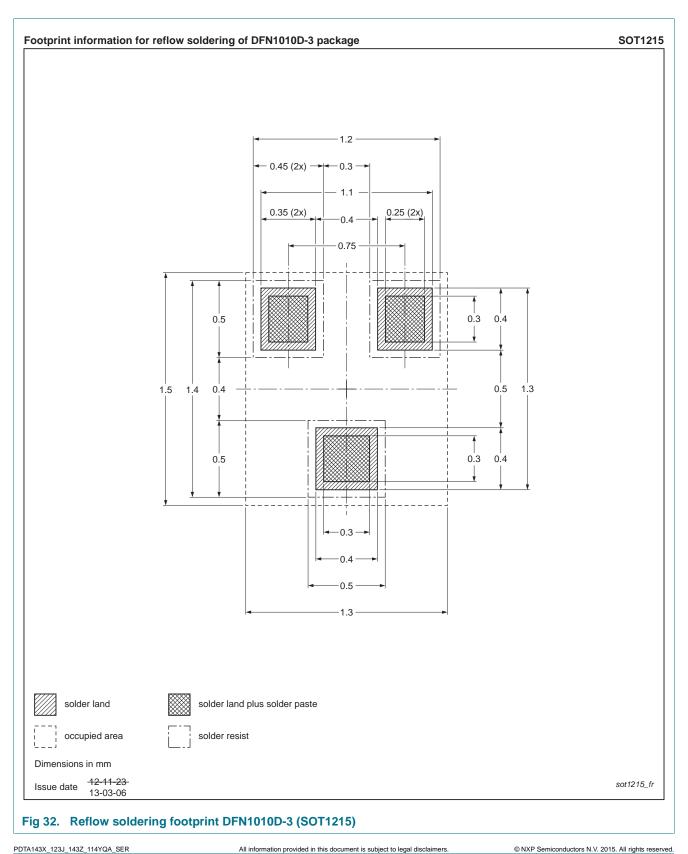
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9. Package outline



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10. Soldering



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11. Revision history

Table 10. Revision history

Document ID	Release date	Data sheet status	Change notice	Supersedes
PDTA143X_123J_143Z_ 114YQA_SER v.1	20151030	Product data sheet	-	-

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12. Legal information

12.1 Data sheet status

Document status[1][2]	Product status ^[3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

[1] Please consult the most recently issued document before initiating or completing a design.

[2] The term 'short data sheet' is explained in section "Definitions"

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